

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc4357hdcdb#trpbf

(Engineering Calculation)

DFN 2mm X 3mm Exp. Pad

(printed on: 2020-07-11 17:35:02)

TOTAL MASS (g) : 0.014907

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000852	1000000	57153.046875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.005723	975000	383904.78125		
		Iron (Fe)	7439-89-6	0.000141	24000	9458.42675781		
		Phosphorus (P)	7723-14-0	0.000002	300	134.162078857		
		Zinc (Zn)	7440-66-6	0.000004	700	268.324157715		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.005870	1000000	393765.6875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000260	1000000	17464.0449219		
		External Plating Total:				0.000260	1000000	17464.0449219
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000136	1000000	9123.02148438		
Internal Plating Total:				0.000136	1000000	9123.02148438		
Die Attach	ELECTRICALLY INSULATING ADHESIVE	Silver (Ag)	7440-22-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000061	440000	4091.94311523		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000078	560000	5232.32080078		
Die Attach Total:				0.000139	1000000	9324.26367188		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.000989	130000	66343.140625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.006545	860000	439045.375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000076	10000	5098.15869141		
		Encapsulation Total:				0.007610	1000000	510486.71875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000040	1000000	2683.24145508		
					TOTAL MASS (g) :	0.014907		